imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



1200V 10A

Zero Recovery Silicon Carbide Schottky Diode

Microsen

PRODUCT APPLICATIONS

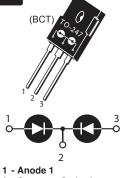
- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Power Factor Correction (PFC)

PRODUCT FEATURES

- Zero Recovery Times (t_{rr}) Popular TO-247 Package
- · Low Forward Voltage
- · Low Leakage Current

PRODUCT BENEFITS

- · Higher Reliability Systems
- · Minimizes or eliminates snubber



- 2 Common Cathode
- Back of Case Cathode 3 - Anode 2

MAXIMUM RATINGS

All Ratings per Leg: T_{C} = 25°C unless otherwise specified.

Symbol	Characteristic / Test Conditions		Ratings	Unit	
V _R	Maximum D.C. Reverse Voltage				
V _{RRM}	Maximum Peak Repetitive Reverse Voltage		1200	Volts	
V _{RWM}	Maximum Working Peak Reverse Voltage				
	Maximum D.C. Forward Current	T _c = 25°C	36		
I _F		T _c = 135°C	10		
I _{FRM}	Repetitive Peak Forward Suge Current ($T_j = 45^{\circ}C$, $t_p = 10ms$, Half Sine Wave)		50	Amps	
I _{FSM}	Non-Repetitive Forward Surge Current ($T_J = 25^{\circ}C$, $t_p = 10ms$, Half Sine)		110		
P _{tot}	Power Dissipation	T _c = 25°C	125	W	
		T _c = 110°C	45	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to 150	С	
TL	Lead Temperature for 10 Seconds		300		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 10A T _J = 25°C		1.5	1.8	Volts
		I _F = 10A, T _J = 150°C		2.1		
I _{RM}	Maximum Reverse Leakage Current	V _R = 1200V T _J = 25°C			200	μA
		V _R = 1200V, T _J = 150°C			1000	
Q _c	Total Capactive Charge V _R = 800V, I _F = 10A, di/dt = -100A/ μ s, T _J = 25°C			30		nC
C _T	Junction Capacitance $V_{R} = 0V$, $T_{J} = 25^{\circ}C$, f = 1MHz			600		
	Junction Capacitance V_{R} = 200V, T_{J} = 25°C, f = 1MHz			71		pF
	Junction Capacitance V_{R} = 400V, T _J = 25°C, f = 1MHz			52		

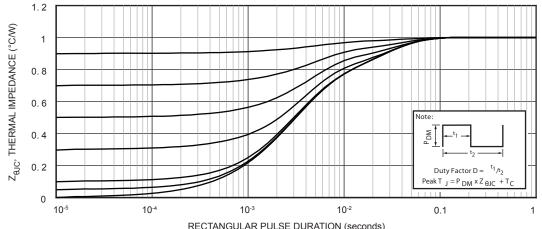
THERMAL AND MECHANICAL CHARACTERISTICS

APT10SCD120BCT

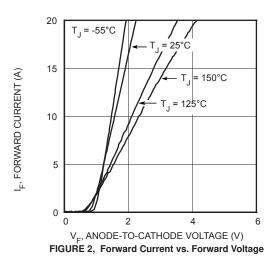
Symbol	Characteristic / Test Conditions	Min	Тур	Мах	Unit
R _{ejc}	Junction-to-Case Thermal Resistance			1.0	°C/W
W _T	Package Weight		0.22		oz
			5.9		g
Torque	Maximum Mounting Torque			10	lb∙in
				1.1	N∙m

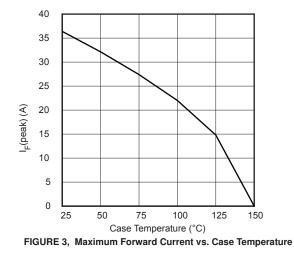
Microsemi reserves the right to change, without notice, the specifications and information contained herein.

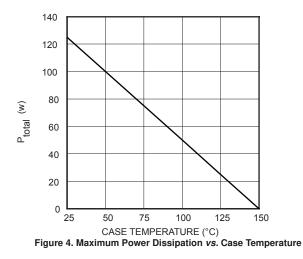
TYPICAL PERFORMANCE CURVES

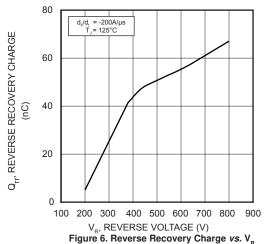


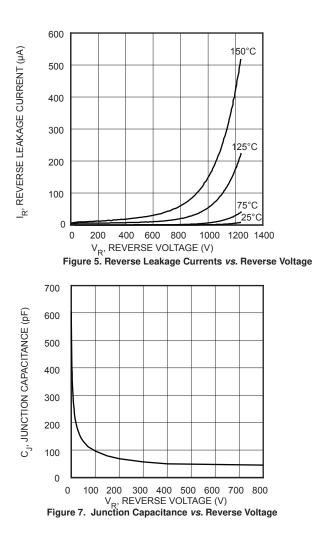




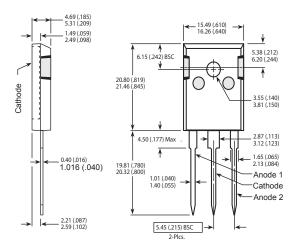












Dimensions in Millimeters and (Inches)

Disclaimer:

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp